

P-QFN-8014 Drawing	Material: N/A	STATUS: Released	SHEET: 1 OF 4	REV. A
Ironwood Electronics, Inc.	Finish: N/A Weight: 41.87	ENG: B. Schatz	DRAWN BY: M. Raske	SCALE: 2:1
www.ironwoodelectronics.com	Weight: 41.07	FILE: SMP-QFN-8014 Dwg	DATE: 03/01/2016	



## Description: Recommended PCB Layout

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams. <u>Tolerances</u>; Hole diameters  $\pm 0.03$ mm [ $\pm 0.001$ "], Hole and pad positions  $\pm 0.025$ mm [ $\pm 0.001$ "], substrate thickness tolerance  $\pm 10\%$ , all other tolerances  $\pm 0.13$ mm [ $\pm 0.005$ "] unless stated otherwise. Materials and specifications are subject to change without notice.

C14040 Drawing	Material: N/A	STATUS: Released	SHEET: 2 OF 4	REV. A
Ironwood Electronics, Inc.	Finish: N/A Weight: 41.87	ENG: B. Schatz	DRAWN BY: M. Raske	SCALE: 4:1
www.ironwoodelectronics.com	Weight. 41.07	FILE: SMP-QFN-8014 Dwg	DATE: 03/01/2016	

## **IRONWOOD COMPATIBLE PACKAGE CODE: QFN56A**



DIM MIN MAX 0.90 А -A1 0.05 b 0.25 L 0.40 D 8.00 BSC D2 5.90 Е 8.00 BSC E2 5.90 0.50 BSC е

Dimensions are in millimeters.

1. Interpret dimensions and tolerances per ASME Y14.5M-1994.

## **Description: Compatible Device**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams. <u>Tolerances</u>: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	C14040 Drawing	Material: N/A	STATUS: Released	SHEET: 3 OF 4	REV. A
	Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com	Finish: N/A Weight: 41.87	ENG: B. Schatz	DRAWN BY: M. Raske	SCALE: 10:1
		Weight. 41.07	FILE: SMP-QFN-8014 Dwg	DATE: 03/01/2016	



ITEM NO.	DESCRIPTION	Material	
1	Latch	Aluminum	
2	Latch Spring	Steel	
3	Lid Spring	Steel	
4	Lid Screw	Steel	
5	Compression Screw	Aluminum	
6	Lid	Aluminum	
7	Compression Plate	Aluminum	
8	Hinge Pin	Steel	
9	Snap Ring	Steel	
10	Compatible Device	N/A	
11	Socket Base	Aluminum	
12	Alignment Pin	Steel	
13	IC Guide	High temp plastic	
14	Protective layer	Gold plated pads	
15	Contactor layer	Silver ball columns in silicon rubber	
16	Target PCB	N/A	
17	Insulation Plate	High temp plastic	
18	Backing Plate	Aluminum	
19	Mounting Screw	Steel	





## INSULATION AND BACKING PLATE DETAIL

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams. <u>Tolerances</u>: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

Description: Socket, Backing Plate Detail

	C14040 Drawing	Material: N/A Finish: N/A Weight: 41.87	STATUS: Released	SHEET: 4 OF 4	REV. A
	Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com		ENG: B. Schatz	DRAWN BY: M. Raske	SCALE: 2:1
		Weight. 41.07	FILE: SMP-QFN-8014 Dwg	DATE: 03/01/2016	